9-70-19-01

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Douglas M. Smith, et al.

Serial No.: Continuation of Serial No. 09/115,854

Filing Date: 01/08/01

Title: Polyol-Based Method for Forming Thin Film

Aerogels On Semiconductor Substrates

Docket No.: TI-22782B

Examiner: To Be Determined

Art Unit: To Be Determined



## **Information Disclosure Statement**

Assistant Commissioner for Patents Box Patent Application Washington, DC 20231

"EXPRESS MAILING" Mailing label No. EL547741105US, Date of Deposit: January 8, 2001.

Dear Sir:

Applicants wish to bring the references noted on the enclosed PTO-1449 to the attention of the Patent and Trademark Office. The enclosed articles and/or patents listed on the attached PTO 1449 form are deemed relevant to the examination of the subject application.

Please charge any additional fees to deposit account 20-0668.

Respectfully submitted,

Texas Instruments Incorporated P. O. Box 655474, M/S 3999 Dallas, Texas 75265 (972) 917-4388 (972) 917-4418 (FAX)

David Denker Reg. No. 40,987 FORM PTO-1449 (REV. 7-80)

## U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

ATTY. DOCKET NO.

SERIAL NO.

LIST OF DOCUMENTS CITED BY APPLICANT
(Use several sheets if necessary)

TI-22782B

Continuation of Serial No. 09/115,854

APPLICANT

Douglas M. Smith, et al.

## GROUP FILING DATE 1/08/01 To Be Determined U.S. PATENT DOCUMENTS **DOCUMENT** \*EXAMINER FILING DATE **SUBCLASS** INITIAL NUMBER DATE NAME **CLASS** (IF APPROPRIATE) AA 5,746,992 5/05/98 Yoldas, et al. 423 338 10/05/95 4/25/95 7/07/94 AB5,409,683 Tillotson, et al. 423 338 4/07/98 778 AC 5,736,425 Smith, et al. 438 11/14/96 AD AE AF AG AH FOREIGN PATENT DOCUMENTS TRANSLATION **DOCUMENT** SUBCLASS COUNTRY NUMBER DATE CLASS YES NO ΑI AJ OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.) AK ALAM<del>BEST AVAILABLE C</del> AN AO AP AQ **EXAMINER** DATE CONSIDERED

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.